

EVM User's Guide: TAS5815PWPEVM

TAS5815PWP Evaluation Module



Description

The TAS5815PWPEVM evaluation module (EVM) helps designers evaluate the operation and performance of the TAS5815PWP Digital Input, Closed-Loop Class-D Amplifier. The TAS5815PWP is a stereo high-performance closed-loop Class-D amp with low power dissipation and advanced audio processing. The graphical user interface or GUI called PurePath™ Control Console 3 is used to interface with USB to the EVM. The EVM has optical SPDIF inputs, I2S, TDM, and audio inputs through the USB interface.

Get Started

1. Order the [TAS5815PWPEVM](#)
2. Download the latest version of the PurePath™ Control Console 3 GUI (PPC3) and request access to TAS5815-SW
3. Read the TAS5815PWPEVM user's guide
4. Refer to the TAS5815 [data sheet](#) or [E2E](#) for questions and support

Features

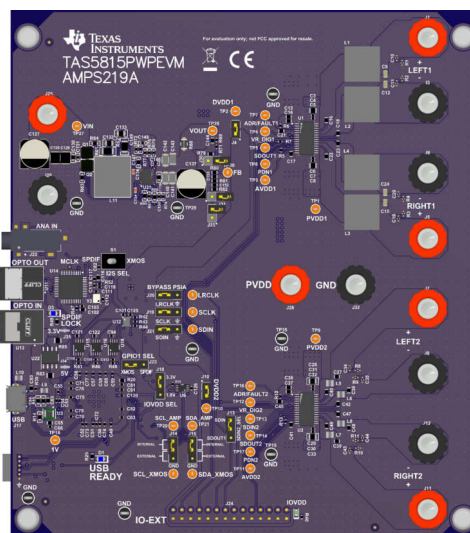
- The integrated DSP of the TAS5815PWP enables Class-H envelope tracking, eliminating the need

for development of complex tracking software or an external microcontroller

- Optional TPS552882 buck-boost can be configured for device A to evaluate Class-H efficiency performance
- Default system configuration: PVDD supplied directly to TAS5815PWP-A and TAS5815PWP-B to evaluate system performance with a L-C filter or the filter-free ferrite bead output configuration
- Provides flexible input signal routing (USB, analog, optical and external I2S)
- Demonstration, evaluation and development environment via the PurePath Console 3 software (GUI)

Applications

- [LCD TV](#), [OLED TV](#), [mobile smart TV](#), [laser TV](#)
- [Smart speakers](#), [smart displays](#), [sound bars](#), [wireless speakers](#)
- [Notebook PC](#), [desktop PC motherboard](#)
- [Piano](#), [keyboard](#), [synthesizer](#), [professional speaker systems](#)
- [Professional conference systems](#), [enterprise projectors](#)



TAS5815PWPEVM

1 Evaluation Module Overview

1.1 Introduction

This user's guide describes the operation of the TAS5815PWP Evaluation Modules (EVM). The TAS5815PWPEVM is a stand-alone EVM. Use the PurePath Control Console 3 GUI (PPC3) to initialize and operate this EVM. To utilize the advanced processing features, use the TAS5815-SW to configure the DSP processing blocks and write I²C commands.

1.2 Kit Contents

- TAS5815PWPEVM
- EVM Disclaimer Read Me

1.3 Specification

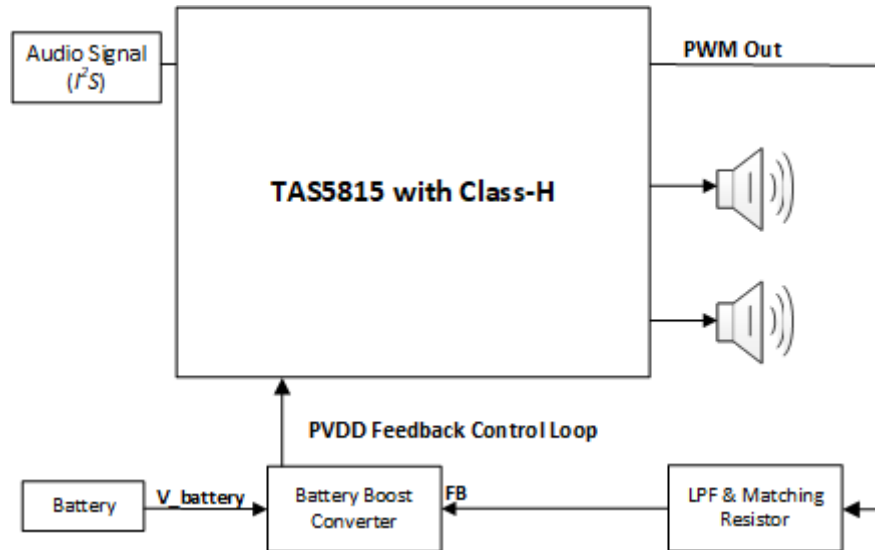


Figure 1-1. TAS5815 Simplified System Diagram

1.4 Device Information

The TAS5815PWPEVM showcases the latest TI digital input Class-D closed loop amplifier. The TAS5815 is a digital input stereo high-efficiency Closed-Loop Class-D audio amplifier with an advanced Class-H algorithm to improve system efficiency and reduce heat without clipping distortion. The TAS5815PWPEVM is a stand-alone EVM, which has an optional battery power supply input with TPS552882 buck-boost or external power supply input bypassing the TPA552882 buck-boost, USB control via PurePath Control Console 3 (PPC3), and flexible audio input options.

2 Hardware

2.1 Setup

Software Control Mode

1. Connect speakers to TAS5815PWPEVM.
2. Connect a PSU to the TAS5815PWPEVM and turn on the power.
3. Plug in a USB cable from the PC to the TAS5815PWPEVM. The USB READY LED (Blue) is also illuminated.
4. If an optical source is used, then the blue SPDIF LOCK LED is illuminated.
5. Make sure jumpers configuration are correct with the appropriate mode:

Table 2-1. Boost Jumpers Configurations

| Jumper | Name | Direct PVDD Supply (Default Configuration) | TPS552882 Buck-Boost Mode Configurations | External Customer Boost Mode Configurations |
|----------|--------------|--------------------------------------------|------------------------------------------|---------------------------------------------|
| J25, J26 | Battery, GND | OUT | IN - Battery input | OUT |
| J28, J32 | PVDD, GND | IN - External PVDD | OUT | IN - External PVDD |
| J27 | PVDD_DCDC | OUT | IN | OUT |
| J29 | PVDD_EXT | IN | OUT | IN |
| J33 | BST_Bypass | OUT | OUT | OUT |
| J30 | Ext_BST | OUT | IN | OUT |
| J31 | ClassH_PWM | OUT | IN | IN |

6. Initialize the TAS5815PWP device using PPC3 to begin playing audio and testing the different features.

2.1.1 I²C Device Addresses

The default 7-bit I²C address on the EVM is set to 0xA0 for the only one TAS5815PWP device.

2.2 Header and Jumper Information

Table 2-2. TAS5815PWP Circuit Jumpers

| Designator | Name | Positions | Description |
|------------|-----------|------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------|
| J4 | DVDD1 | IN: Default, IOVDD supplies DVDD for device 1 OUT: DVDD disconnected for device 1 | Drives the digital power supply for the first TAS5815PWP. If DVDD current draw wants to be measured need to externally drive DVDD to pin 2 |
| J10 | DVDD2 | IN: Default, IOVDD supplies DVDD for device 2 OUT: DVDD disconnected for device 2 | Drives the digital power supply for the second TAS5815PWP. If DVDD current draw wants to be measured need to externally drive DVDD to pin 2 |
| J2 | PVDD1 | IN: Default, PVDD_5815 supplies PVDD for device 1 OUT: PVDD disconnected for device 1 | Drives the analog power supply for the first TAS5815PWP device |
| J9 | PVDD2 | IN: Default, PVDD_5815 supplies PVDD for device 2 OUT: PVDD disconnected for device 2 | Drives the analog power supply for the second TAS5815PWP device |
| J13 | SDIN2_SEL | 1-2: Default, SDIN from I2S MUX 2-3: SDOOUT from Device A | Selects the SDIN for the second TAS5815PWP |
| J1 | Left1A | N/A | Positive output for the left channel of device 1 |
| J3 | Left1B | N/A | Negative output for the left channel of device 1 |
| J5 | Right1A | N/A | Positive output for the right channel of device 1 |
| J6 | Right1B | N/A | Negative output for the right channel of device 1 |
| J7 | Left2A | N/A | Positive output for the left channel of device 2 |
| J8 | Left2B | N/A | Negative output for the left channel of device 2 |
| J11 | Right2A | N/A | Positive output for the right channel of device 2 |
| J12 | Right2B | N/A | Negative output for the right channel of device 2 |

Table 2-3. R6: Device 1 - I²C Address

| R6 | Address |
|-------|---------|
| 4.7kΩ | 0xA8 |
| 15kΩ | 0xAA |
| 47kΩ | 0xAC |
| 120kΩ | 0xAE |

Table 2-4. R12: Device 2 - I²C Address

| R12 | Address |
|-------|---------|
| 4.7kΩ | 0xA8 |
| 15kΩ | 0xAA |
| 47kΩ | 0xAC |
| 120kΩ | 0xAE |

Table 2-5. XMOS Circuit Jumpers

| Designator | Name | Position | Description |
|------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| J14 | SCL | 1-2: Default, PPC3 drives XMOS I2C bus to the TAS5815PWPs OUT: Use Pin 1 and 3 to drive SCL externally to the two TAS5815PWP on the EVM | The SCL Jumper offers a few options to provide or receive I2C signals. Default configuration connects the XMOS I2C bus to the two TAS5815PWP to configure the device with PPC3. Disconnecting the jumper allows for the XMOS I2C bus to be connected to an external TAS5815 system board to configure that device with PPC3 using pins 2 and 3. Alternatively can use an external I2C bus to drive the two TAS5815PWP on the EVM using pins 1 and 3. |
| J15 | SDA | 1-2: Default, PPC3 drives XMOS I2C bus to the two TAS5815PWP OUT: Use Pin 1 and 3 to drive SDA externally to the two TAS5815PWP on the EVM | The SDA Jumper offers a few options to provide or receive I2C signals. Default configuration connects the XMOS I2C bus to the two TAS5815PWP to configure the device with PPC3. Disconnecting the jumper allows for the XMOS I2C bus to be connected to an external TAS5815 system board to configure that device with PPC3 using pins 2 and 3. Alternatively can use an external I2C bus to drive the two TAS5815PWP on the EVM using pins 1 and 3. |

Table 2-6. Audio Input IO Circuit Jumpers and Switches

| Designator | Name | Positions | Description |
|------------|-----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| J18 | IOVDD SEL | 1-2: 1.8V IOVDD 2-3: Default, 3.3V IOVDD | Sets the IOVDD voltage for the Digital Interfaces |
| J19 | SCLK | 1-2: Default, Bypass mode that sends SPDIF/XMOS I2S input to the two TAS5815PWP 2-3: Connect external PSIA connector to Pin 2-3 to drive input to the two TAS5815PWP | Sets the SCLK input to be driven internally using USB or optical input or driven externally with a PSIA connector |
| J20 | LRCLK | 1-2: Default, Bypass mode that sends SPDIF/XMOS I2S input to the two TAS5815PWP 2-3: Connect external PSIA connector to Pin 2-3 to drive input to the two TAS5815PWP | Sets the LRCLK input to be driven internally using USB or optical input or driven externally with a PSIA connector |
| J21 | SDIN | 1-2: Default, Bypass mode that sends SPDIF/XMOS I2S input to the two TAS5815PWP 2-3: Connect external PSIA connector to Pin 2-3 to drive input to the two TAS5815PWP | Sets the SDIN input to be driven internally using USB or optical input or driven externally with a PSIA connector |
| J23 | GPIO1 SEL | 1-2: Default, sends the SDOOUT data to the XMOS 2-3: Sends SDOOUT Data to SPDIF Optical Output | If the device is not using the Class-H feature, then this jumper can be using to sent the output I2S/TDM data to an external source of either the XMOS and USB or the optical output |
| S1 | I2S SEL | XMOS: Default, audio input from XMOS SPDIF: Audio input from SPDIF | Sets the audio input source for the two TAS5815PWP on the EVM |

Table 2-7. Power Supply Circuit Jumpers

| Designator | Name | Positions | Description |
|------------|------------|---------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------|
| J30 | Ext_BST | IN: Default, TAS5815PWP Class H PWM output drives the TPS552882 Buck-Boost voltage through the Feedback Pin OUT: Disconnect Class H PWM signal | This jumper is used to connect the TPS552882 Feedback Pin to the voltage generated by the Class H PWM Control Signal of the TAS5815PWP |
| J33 | BST_Bypass | IN: Max BST Output OUT: Default | When the device is using Class-H, shorting the BST Bypass jumper sets the TPS552882 Boost to the max Boost Output |
| J31 | ClassH_PWM | IN: Default, TAS5815PWP Class H PWM output is sent to the TPS552882 OUT: Disconnect TAS5815PWP Class H PWM signal | When using Class H, shorting this jumper lets the TAS5815PWP drive the TPS552882 Buck-Boost voltage. |
| J34 | 5V | N/A | The 5V rail used to power various components on the EVM. |
| J35 | 3.3V | N/A | The 3.3V rail used to power various components on the EVM. |
| J27 | PVDD_DCDC | IN: TPS552882 Buck-Boost voltage is sent to the TAS5815PWP OUT: Default, no Buck-Boost connection | This jumper lets the user decide to use the TPS552882 Buck-Boost voltage for the TAS5815PWP devices |
| J29 | PVDD_EXT | IN: Default, an external PVDD is sent to the TAS5815PWP OUT: no external PVDD connection | This jumper lets the user decide to use an external PVDD supply for the TAS5815PWP devices |
| J25 | Battery | N/A | Battery input to the TAS5815PWP EVM |
| J28 | PVDD | N/A | External PVDD input to the TAS5815PWP EVM |
| J26/J32 | GND | N/A | Battery and PVDD ground inputs to the TAS5815PWP EVM |

Table 2-8. J24: IO-EXT Pin Description

| Number | Name | Description |
|------------------------|------------------|------------------------------------------------------------------------------------------------|
| All odd pins (1 to 27) | GND | Ground connection |
| 2 | IOVDD | The 3.3V or 1.8V digital power supply |
| 4,6 | N/A | Unused floating pins |
| 8 | SCL | I ² C serial control clock input for the TAS5815PWP |
| 10 | SDA | I ² C serial control clock input for the TAS5815PWP |
| 12 | LRCLK | I ² S/TDM Frame Clock |
| 14 | SCLK | I ² S/TDM Bit Clock |
| 16 | SDIN | I ² S/TDM Data |
| 18 | SDOUT_Hybrid_Pro | General-purpose input/output configured to be the Class-H PWM control pin or SDOUT of device 1 |
| 20 | SDOUT2 | General-purpose input/output configured to be the SDOUT of device 2 |
| 22 | PDN1 | Power down signal for device 1 |
| 24 | PDN2 | Power down signal for device 2 |
| 26 | ADR_FAULT1 | Address and fault signal for device 1 |
| 28 | ADR_FAULT2 | Address and fault signal for device 2 |

2.3 Test Points

Table 2-9. Test Points

| Designator | Name | Description |
|--------------|------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TP1 | PVDD1 | PVDD voltage supply device 1 |
| TP2 | DVDD1 | DVDD voltage supply of device 1 |
| TP3 | AVDD1 | AVDD internally regulated voltage of device 1 |
| TP4 | VR_DIG1 | VR_DIG internally regulated voltage of device 1 |
| TP5 | SDOUT1 | General-purpose input/output configured to be the Class-H PWM control pin or SDOUT for device 1 |
| TP7 | ADR_FAULT1 | Fault terminal for device 1, which is pulled LOW when an internal fault occurs |
| TP8 | PDN1 | Power down, active-low for device 1. PDN place the amplifier in Shutdown, turn off all internal regulators |
| TP9 | PVDD2 | PVDD voltage supply device 2 |
| TP10 | DVDD2 | DVDD voltage supply of device 2 |
| TP11 | AVDD2 | AVDD internally regulated voltage of device 2 |
| TP12 | VR_DIG2 | VR_DIG internally regulated voltage of device 2 |
| TP13 | SDIN2 | Serial Data Input to device 2 |
| TP14 | SDOUT2 | General-purpose input/output configured to be the Class-H PWM control pin or SDOUT for device 2 |
| TP16 | ADR_FAULT2 | Fault terminal for device 2, which is pulled LOW when an internal fault occurs |
| TP17 | PDN2 | Power down, active-low for device 2. PDN place the amplifier in Shutdown, turn off all internal regulators |
| TP18 | 1V | The 1V rail used in the XMOS |
| TP19 | SCL_XMOS | Probe point for the I2C serial clock input going generated by the XMOS |
| TP20 | SCL_AMP | Probe point for the I2C serial clock input going into the two TAS5815PWP |
| TP21 | SDA_AMP | The I2C serial control data interface input/output going into the two TAS5815PWP |
| TP22 | SDA_XMOS | The I2C serial control data interface input/output generated by the XMOS |
| TP24 | SCLK | Bit clock for the digital signal that is active on the input data line of the serial data port |
| TP25 | LRCLK | Word select clock for the digital signal that is active on the serial port's input data line. In I2S, LJ and RJ, this corresponds to the left channel and right channel boundary. In TDM mode, this corresponds to the frame sync boundary |
| TP26 | SDIN | Data line to the serial data port |
| TP27 | VIN | Battery input voltage into the TPS552882 |
| TP28 | VOUT | TPS552882 boost output voltage |
| TP30 | FB | TPS552882 Feedback pin used to control the output boost voltage |
| All other TP | GND | Ground reference pins for probes |

3 Hardware Design Files

3.1 Schematics

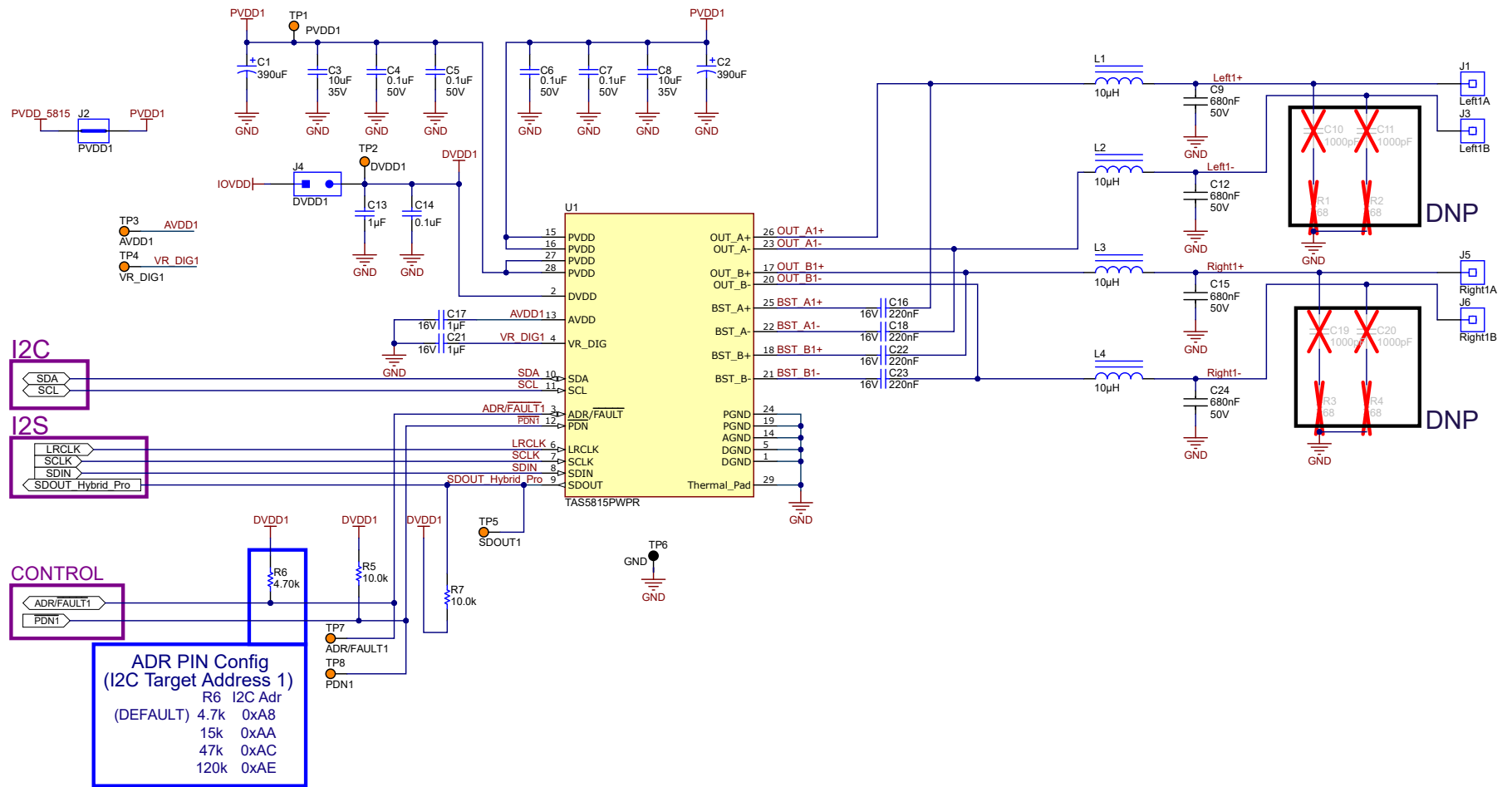


Figure 3-1. TAS5815PWPEVM Schematic (1 of 6)

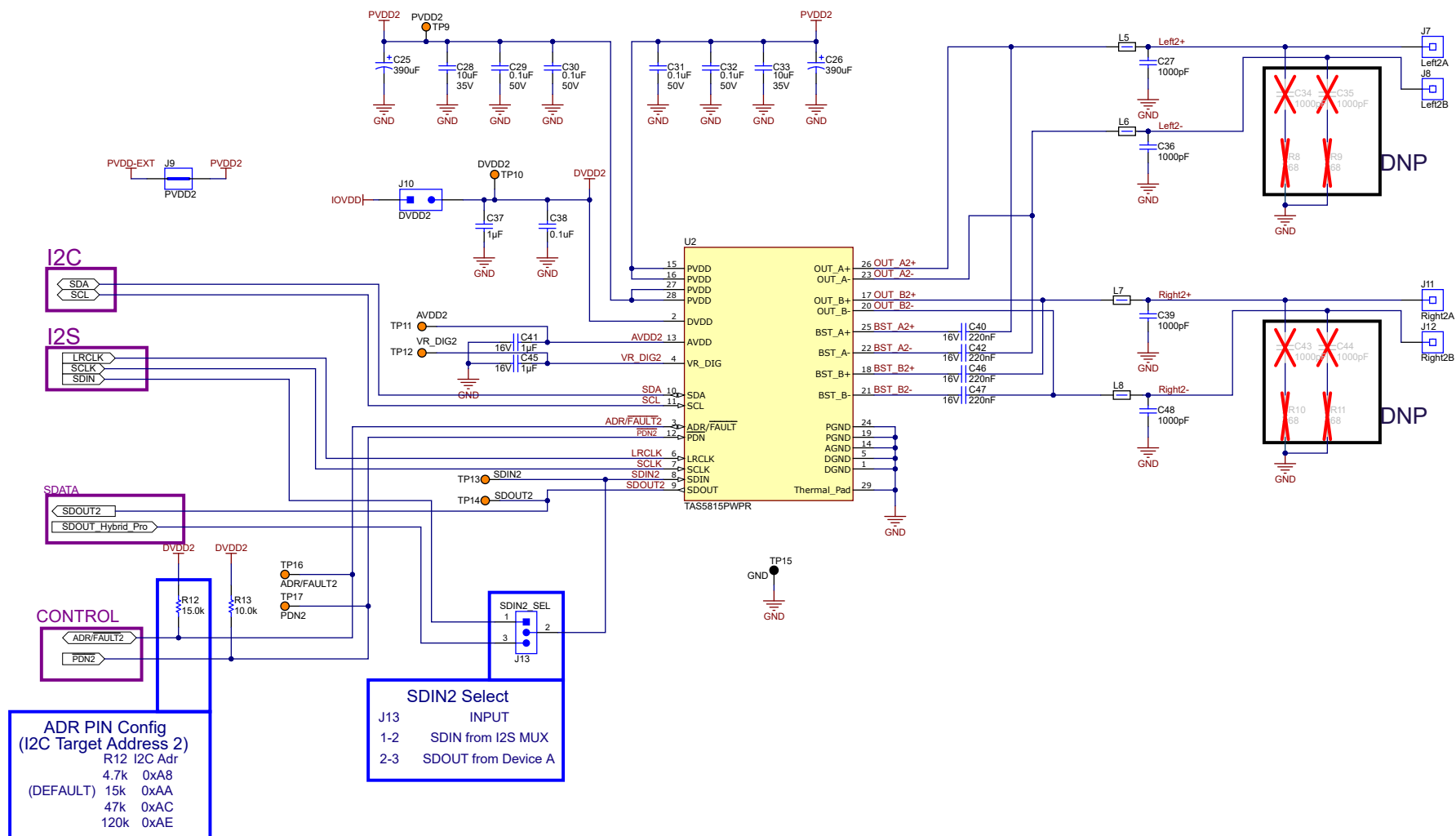


Figure 3-2. TAS5815PWPEVM Schematic (2 of 6)

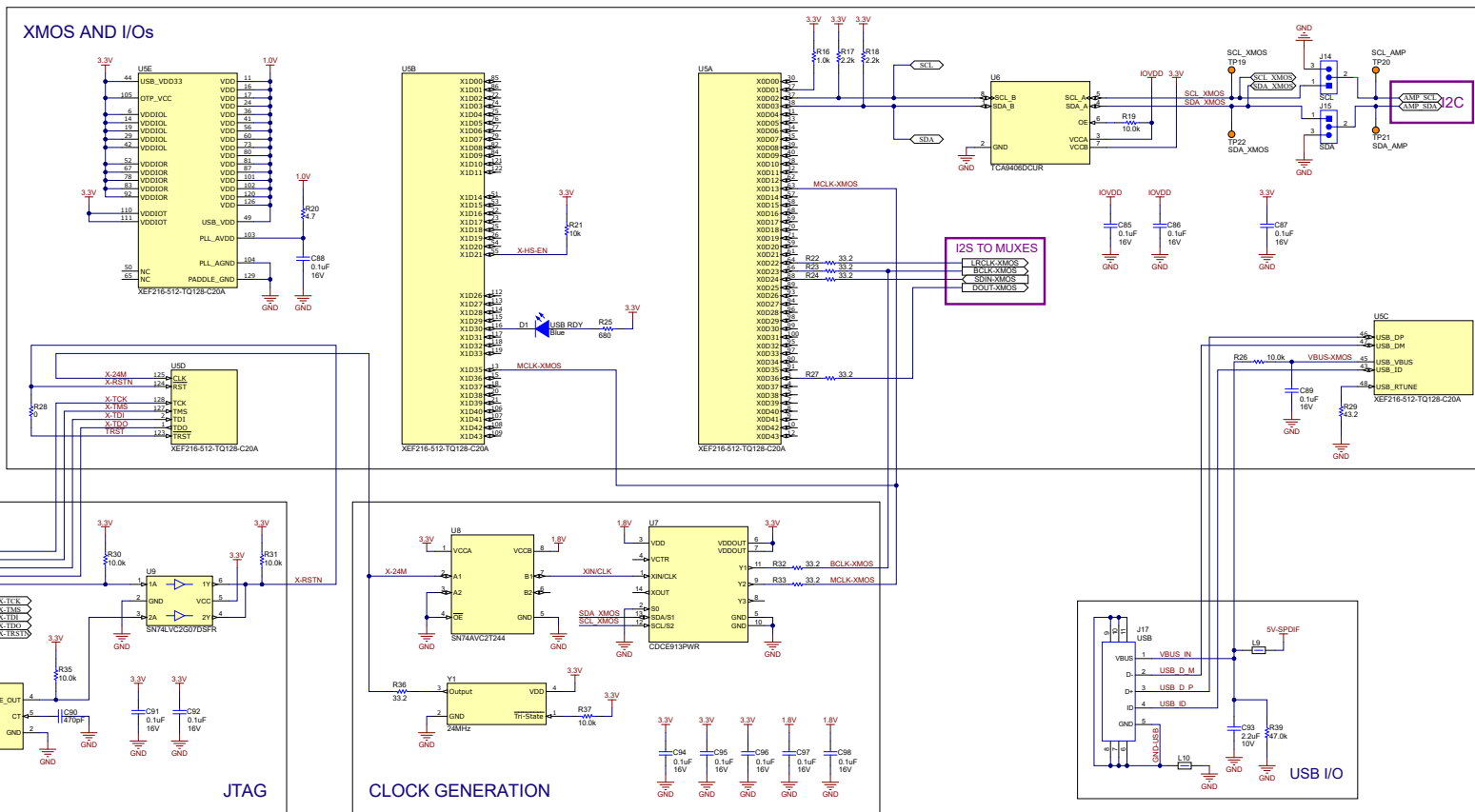
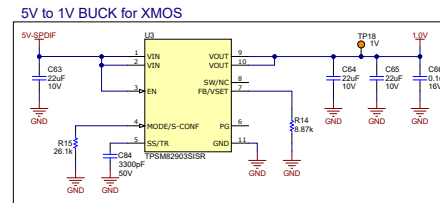
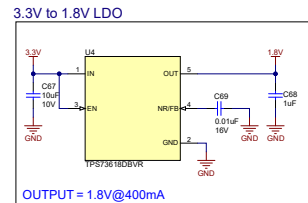
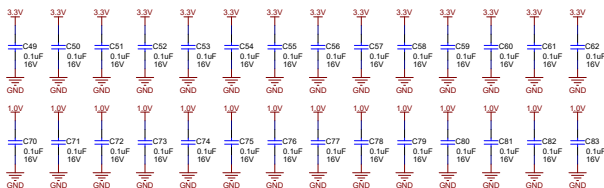


Figure 3-3. TAS5815PWPEVM Schematic (3 of 6)

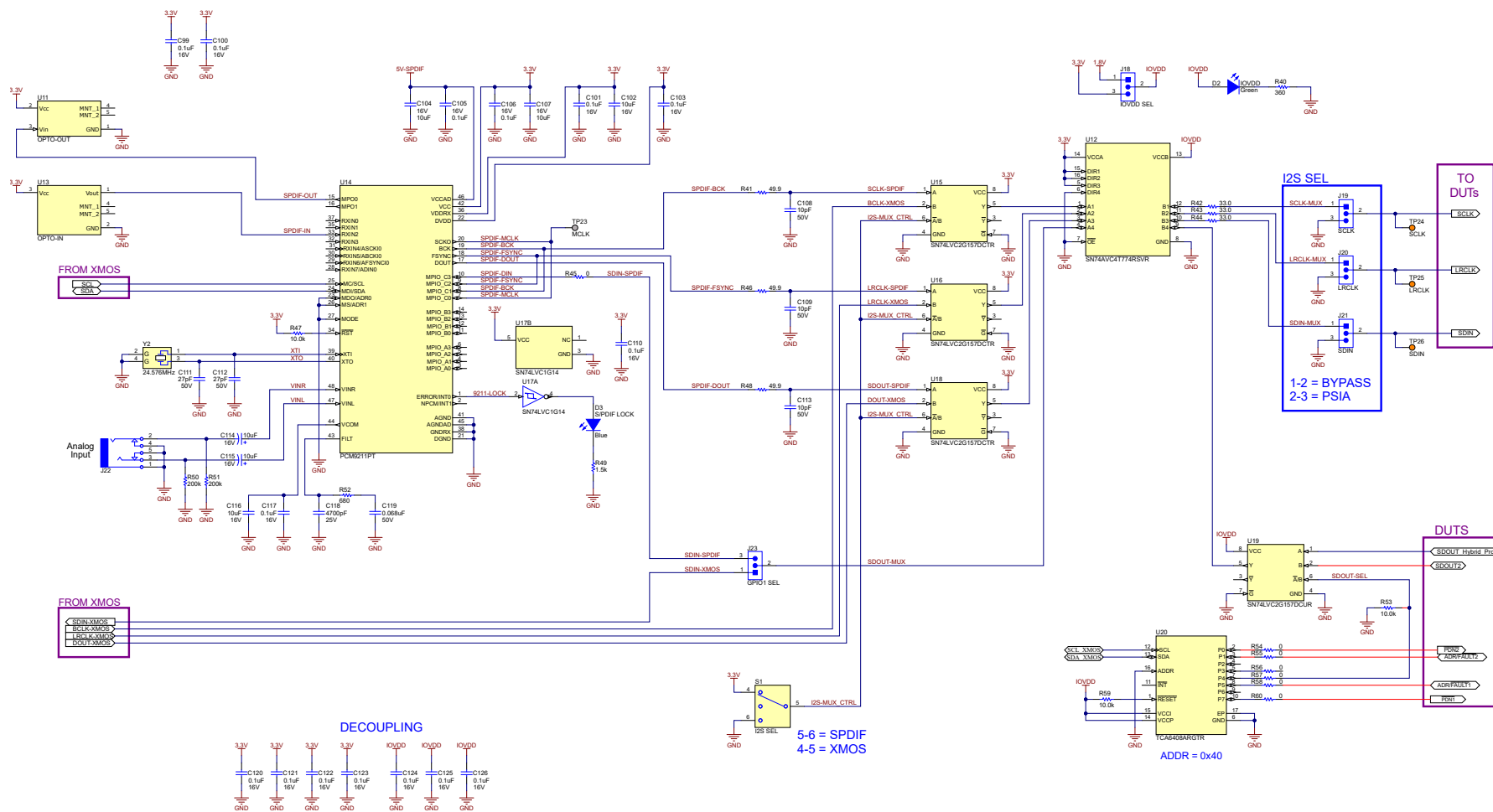


Figure 3-4. TAS5815PWPEVM Schematic (4 of 6)

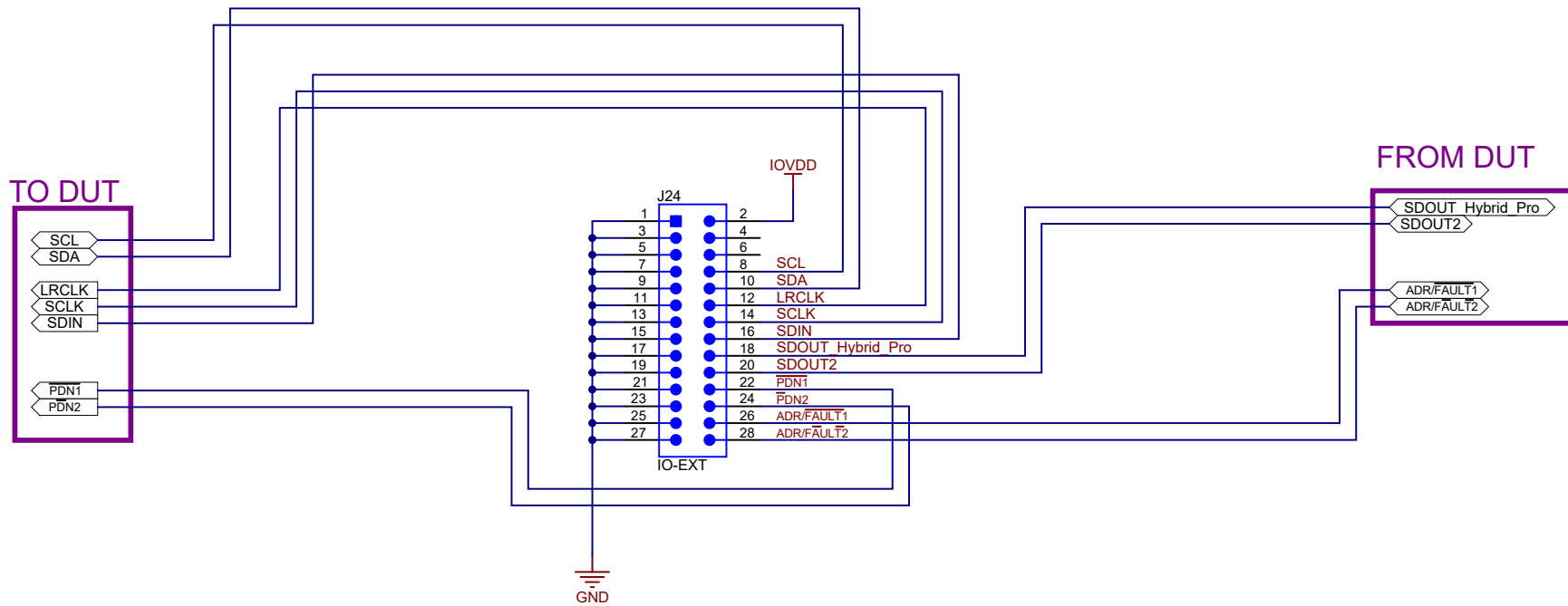


Figure 3-5. TAS5815PWPEVM Schematic (5 of 6)

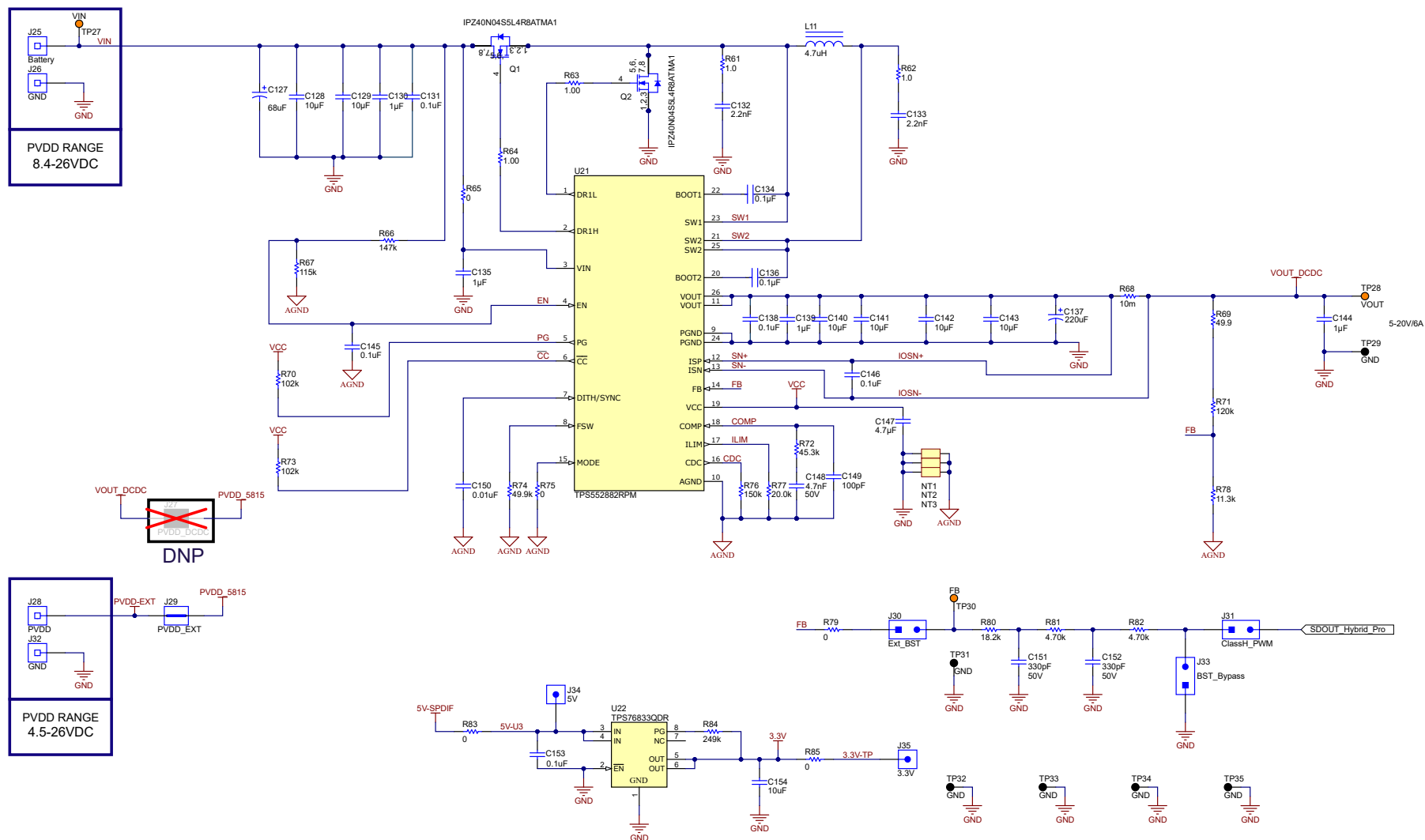
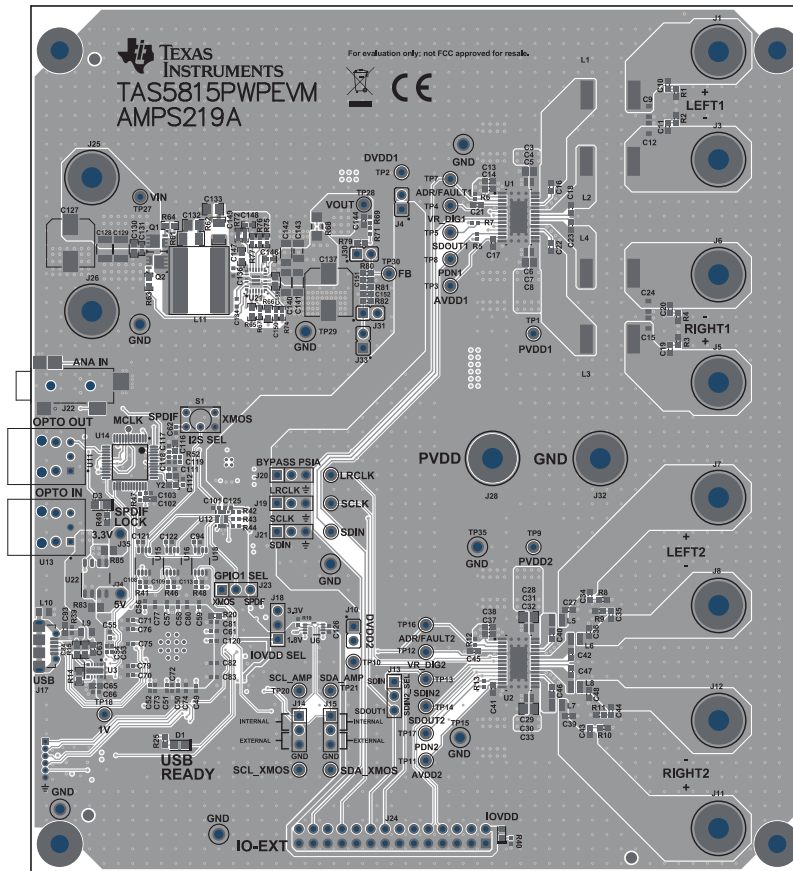


Figure 3-6. TAS5815PWPEVM Schematic (6 of 6)

3.2 PCB Layout

Figure 3-7 and Figure 3-8 illustrate the board layouts for the EVM.



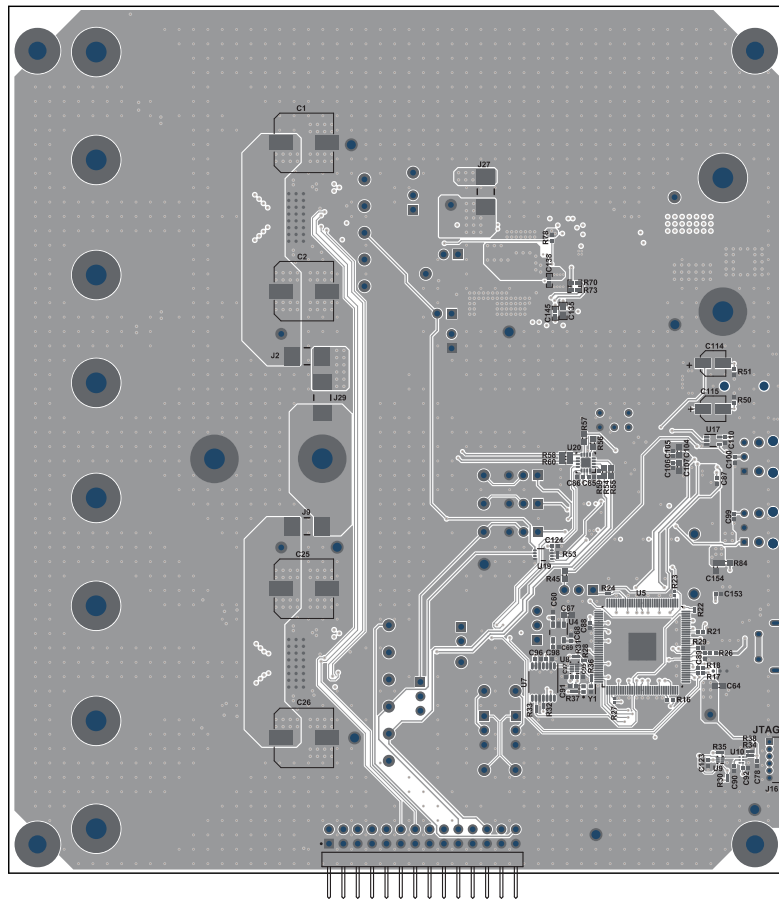


Figure 3-8. TAS5815PWPEVM Bottom Overlay

3.3 Bill of Materials

Table 3-1. Bill of Materials

| Designator | QTY | Value | Description | Package Reference | Part Number | Manufacturer | Alternate Part Number | Alternate Manufacturer |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|--------|-------------------------------------------------------------|-------------------|----------------------|---------------------------|-----------------------|------------------------|
| C1, C2, C25, C26 | 4 | 390uF | CAP, AL, 390uF, 35V, +/- 20%, 0.08 ohm, SMD | 10x10 | UCL1V391MNL1GS | Nichicon | | |
| C3, C8, C28, C33 | 4 | 10uF | CAP, CERM, 10uF, 35V, +/- 10%, X5R, 0805 | 0805 | GRM21BR6YA106KE43L | MuRata | | |
| C4, C5, C6, C7, C29, C30, C31, C32, C131, C138, C145, C146 | 12 | 0.1uF | CAP, CERM, 0.1uF, 50V, +/- 10%, X7R, AEC-Q200 Grade 1, 0402 | 0402 | CGA2B3X7R1H104K050BB | TDK | | |
| C9, C12, C15, C24 | 4 | | CAP CER 0.68UF 50V X7R 0805 | 0805 | CGA4J3X7R1H684M125AB | TDK Corporation | | |
| C13, C37 | 2 | 1uF | CAP, CERM, 1uF, 25V, +/- 10%, X7R, 0603 | 0603 | C0603C105K3RACTU | Kemet | | |
| C14, C38 | 2 | 0.1uF | CAP, CERM, 0.1uF, 50V, +/- 10%, X7R, 0603 | 0603 | C0603C104K5RACTU | Kemet | | |
| C16, C18, C22, C23, C40, C42, C46, C47 | 8 | 0.22uF | CAP, CERM, 0.22uF, 16V, +/- 10%, X7R, 0603 | 0603 | C1608X7R1C224K080AC | TDK | | |
| C17, C21, C41, C45 | 4 | 1uF | CAP, CERM, 1µF, 16V, +/- 10%, X7R, 0603 | 0603 | CL10B105K08NFNC | Samsung Electro-Mechanics | | |
| C27, C36, C39, C48 | 4 | 1000pF | CAP, CERM, 1000pF, 100V, +/- 10%, X7R, 0603 | 0603 | 06031C102KAT2A | AVX | | |
| C49, C50, C51, C52, C53, C54, C55, C56, C57, C58, C59, C60, C61, C62, C66, C70, C71, C72, C73, C74, C75, C76, C77, C78, C79, C80, C81, C82, C83, C85, C86, C87, C88, C89, C91, C92, C94, C95, C96, C97, C98, C99, C100, C101, C103, C105, C106, C110, C117, C120, C121, C122, C123, C124, C125, C126, C153 | 57 | 0.1uF | CAP, CERM, 0.1uF, 16V, +/- 10%, X7R, 0402 | 0402 | 8.85012E+11 | Würth Elektronik | | |

Table 3-1. Bill of Materials (continued)

| Designator | QTY | Value | Description | Package Reference | Part Number | Manufacturer | Alternate Part Number | Alternate Manufacturer |
|------------------------|-----|---------|---------------------------------------------------------------|-------------------|----------------------|----------------------------------|-----------------------|----------------------------|
| C63, C64, C65 | 3 | 22uF | CAP, CERM, 22uF, 10V, +/- 20%, X5R, 0603 | 0603 | C1608X5R1A226M080AC | TDK | | |
| C67, C154 | 2 | 10uF | CAP, CERM, 10uF, 10V, +/- 20%, X5R, 0603 | 0603 | C1608X5R1A106M080AC | TDK | | |
| C68 | 1 | 1uF | CAP, CERM, 1uF, 6.3V, +/- 20%, X5R, 0402 | 0402 | GRM152R60J105ME15D | MuRata | | |
| C69 | 1 | 0.01uF | CAP, CERM, 0.01uF, 16V, +/- 10%, X7R, 0402 | 0402 | 8.85012E+11 | Würth Elektronik | | |
| C84 | 1 | 3300pF | CAP, CERM, 3300pF, 50V, +/- 5%, COG/NPO, 0603 | 0603 | GRM1885C1H332JA01D | MuRata | | |
| C90 | 1 | 470pF | CAP, CERM, 470pF, 50V, +/- 5%, COG/NPO, 0402 | 0402 | GRM1555C1H471JA01D | MuRata | | |
| C93 | 1 | 2.2uF | CAP, CERM, 2.2uF, 10V, +/- 10%, X7R, 0603 | 0603 | GRM188R71A225KE15D | MuRata | | |
| C102, C104, C107, C116 | 4 | 10uF | CAP, CERM, 10uF, 16V, +/- 20%, X5R, 0603 | 0603 | EMK107BBJ106MA-T | Taiyo Yuden | GMC10X5R106M16NT | CAL-CHIP ELECTRONICS, INC. |
| C108, C109, C113 | 3 | 10pF | CAP, CERM, 10pF, 50V, +/- 5%, COG/NPO, 0402 | 0402 | 8.85012E+11 | Würth Elektronik | | |
| C111, C112 | 2 | 27pF | CAP, CERM, 27pF, 50V, +/- 5%, COG/NPO, 0402 | 0402 | GJM1555C1H270JB01D | MuRata | | |
| C114, C115 | 2 | 10uF | CAP, AL, 10uF, 16V, +/- 20%, SMD | D55 | EMVE160ADA100MD55G | Chemi-Con | UWX1C100MCL1GB | Nichicon |
| C118 | 1 | 4700pF | CAP, CERM, 4700pF, 25V, +/- 10%, X7R, 0402 | 0402 | CC0402KRX7R8BB472 | Yageo | | |
| C119 | 1 | 0.068uF | CAP, CERM, 0.068uF, 50V, +/- 10%, X7R, AEC-Q200 Grade 1, 0402 | 0402 | CGA2B3X7R1H683K050BB | TDK | | |
| C127 | 1 | 68uF | CAP, Polymer Hybrid, 68uF, 50V, +/- 20%, 30 ohm, 8x10 SMD | 8x10 | EEHZA1H680P | Panasonic | | |
| C128, C129 | 2 | 10uF | CAP, CERM, 10uF, 75V, +/- 20%, X7R, AEC-Q200 Grade 1, 1210 | 1210 | CGA6P1X7R1N106M250AC | TDK | | |
| C130, C135, C139, C144 | 4 | 1uF | CAP, CERM, 1uF, 50V, +/- 20%, X5R, AEC-Q200 Grade 3, 0603 | 0603 | GRT188R61H105ME13D | MuRata | | |
| C132, C133 | 2 | 2200pF | CAP, CERM, 2200pF, 250V, +/- 10%, X7R, 0805 | 0805 | GRM21AR72E222KW01D | MuRata | | |
| C134, C136 | 2 | | 0.1uF ±10% 50V Ceramic Capacitor X8L 0603 (1608 Metric) | 0603 | GCM188L81H104KA57D | Murata Electronics North America | | |
| C137 | 1 | 220uF | CAP, Polymer Hybrid, 220uF, 25V, +/- 20%, 27 ohm, 8x10 SMD | 8x10 | EEHZC1E221P | Panasonic | | |

Table 3-1. Bill of Materials (continued)

| Designator | QTY | Value | Description | Package Reference | Part Number | Manufacturer | Alternate Part Number | Alternate Manufacturer |
|----------------------------------------|-----|--------|-----------------------------------------------------------------|----------------------------------------------------|----------------------|-----------------------------|-----------------------|------------------------|
| C140, C141, C142, C143 | 4 | 10uF | CAP, CERM, 10µF, 50V, +/- 10%, X7R, AEC-Q200 Grade 1, 1206 | 1206 | CGA5L1X7R1H106K160AC | TDK | | |
| C147 | 1 | 4.7uF | CAP, CERM, 4.7µF, 16V, +/- 10%, X5R, AEC-Q200 Grade 3, 0603 | 0603 | GRT188R61C475KE13D | MuRata | | |
| C148 | 1 | 4700pF | CAP, CERM, 4700pF, 50V, +/- 10%, X7R, AEC-Q200 Grade 1, 0402 | 0402 | CGA2B2X7R1H472K050BA | TDK | | |
| C149 | 1 | 100pF | CAP, CERM, 100pF, 50V, +/- 5%, COG/NPO, AEC-Q200 Grade 1, 0402 | 0402 | CGA2B2C0G1H101J050BA | TDK | | |
| C150 | 1 | 0.01uF | CAP, CERM, 0.01uF, 50V, +/- 10%, X7R, AEC-Q200 Grade 1, 0402 | 0402 | CGA2B3X7R1H103K050BB | TDK | | |
| C151, C152 | 2 | 330pF | CAP, CERM, 330pF, 50V, +/- 5%, COG/NPO, 0603 | 0603 | C0603C331J5GACTU | Kemet | | |
| D1, D3 | 2 | Blue | LED, Blue, SMD | LED_0805 | LTST-C170TBKT | Lite-On | | |
| D2 | 1 | Green | LED, Green, SMD | LED_0603 | 150060GS75000 | Würth Elektronik | | |
| H1, H2, H3, H4 | 4 | | Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead | Screw | NY PMS 440 0025 PH | B&F Fastener Supply | | |
| H5, H6, H7, H8 | 4 | | Standoff, Hex, 0.5"L #4-40 Nylon | Standoff | 1902C | Keystone | | |
| J1, J5, J7, J11, J25, J28 | 6 | | Binding Post, RED, TH | 11.4x27.2mm | 7006 | Keystone | | |
| J2, J9, J29 | 3 | | JUMPER TIN SMD | 6.85x0.97x2.5 1 mm | S1911-46R | Harwin | | |
| J3, J6, J8, J12, J26, J32 | 6 | | Binding Post, BLACK, TH | 11.4x27.2mm | 7007 | Keystone | | |
| J4, J10, J30, J31, J33 | 5 | | Header, 100mil, 2x1, Gold, TH | Sullins 100mil, 1x2, 230 mil above insulator | PBC02SAAN | Sullins Connector Solutions | | |
| J13, J14, J15, J18, J19, J20, J21, J23 | 8 | | Header, 100mil, 3x1, Gold, TH | PBC03SAAN | PBC03SAAN | Sullins Connector Solutions | | |
| J16 | 1 | | Receptacle, 50mil, 6x1, Gold, R/A, TH | 6x1 Receptacle | LPPB061NGCN-RC | Sullins Connector Solutions | | |
| J17 | 1 | | Connector, Receptacle, Micro-USB Type AB, R/A, Bottom Mount SMT | 5.6x2.5x8.2m m | 475890001 | Molex | | |
| J22 | 1 | | Audio Jack, 3.5mm, Stereo, R/A, SMT | Phone Jack, 6x5x17mm | 35RASMT4BHNTRX | Switchcraft | | |
| J24 | 1 | | Header, 100mil, 14x2, Gold, R/A, TH | 14x2 R/A Header | TSW-114-08-G-D-RA | Samtec | | |
| J34, J35 | 2 | | | Test point, TH Slot Test point | 1040 | Keystone | | |

Table 3-1. Bill of Materials (continued)

| Designator | QTY | Value | Description | Package Reference | Part Number | Manufacturer | Alternate Part Number | Alternate Manufacturer |
|-----------------------------------|-----|---------|----------------------------------------------------------|------------------------|---------------------|-----------------------|--------------------------|------------------------|
| L1, L2, L3, L4 | 4 | 10uH | Inductor, Shielded, Ferrite, 10μH, 4.4A, 0.0304 ohm, SMD | | 1274AS-H-100M=P3 | MuRata | | |
| L5, L6, L7, L8 | 4 | 300 ohm | Ferrite Bead, 300 ohm at 100MHz, 3.1A, 0806 | 0806 | NFZ2MSM301SN10L | MuRata | | |
| L9, L10 | 2 | 600 ohm | Ferrite Bead, 600 ohm at 100MHz, 2A, 0805 | 0805 | MPZ2012S601AT000 | TDK | | |
| L11 | 1 | 4.7uH | Inductor, Shielded, Composite, 4.7uH, 24A, 0.01 ohm, SMD | Inductor, 11.3x10x10mm | XAL1010-472MEB | Coilcraft | | |
| Q1, Q2 | 2 | 40V | MOSFET, N-CH, 40V, 40A, AEC-Q101, SON-8 | SON-8 | IPZ40N04S5L4R8ATMA1 | Infineon Technologies | | None |
| R5, R13 | 2 | 15.0k | RES, 15.0 k, .1%, .063 W, AEC-Q200 Grade 0, 0402 | 0402 | ERA-2AEB153X | Panasonic | | |
| R6 | 1 | 4.70k | RES, 4.70 k, 1%, 0.0625 W, 0402 | 0402 | RC0402FR-074K7L | Yageo America | | |
| R7, R21 | 2 | 10k | RES, 10 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040210K0JNED | Vishay-Dale | [NoValue], ERJ-U02F1002X | [NoValue], Panasonic |
| R12 | 1 | 15.0k | RES, 15.0 k, 1%, 0.063 W, 0402 | 0402 | RC0402FR-0715KL | Yageo America | | |
| R14 | 1 | 8.87k | RES, 8.87 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | CRCW06038K87FKEA | Vishay-Dale | | |
| R15 | 1 | 26.1k | RES, 26.1 k, 0.1%, 0.1 W, 0603 | 0603 | RT0603BRD0726K1L | Yageo America | | |
| R16 | 1 | 1.0k | RES, 1.0 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04021K00JNED | Vishay-Dale | CRCW04021K00JNTD | Vishay Dale |
| R17, R18 | 2 | 2.2k | RES, 2.2 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04022K20JNED | Vishay-Dale | | |
| R19, R26 | 2 | 10.0k | RES, 10.0 k, 1%, 0.1 W, 0402 | 0402 | ERJ-2RKF1002X | Panasonic | ERJ-U02F1002X | Panasonic |
| R20 | 1 | 4.7 | RES, 4.7, 5%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | CRCW06034R70JNEA | Vishay-Dale | | |
| R22, R23, R24, R27, R32, R33, R36 | 7 | 33.2 | RES, 33.2, 1%, 0.05 W, 0201 | 0201 | RC0201FR-0733R2L | Yageo America | | |
| R25 | 1 | 680 | RES, 680, 1%, 0.1 W, 0603 | 0603 | RC0603FR-07680RL | Yageo | | |
| R28 | 1 | 0 | RES, 0, 5%, .05 W, AEC-Q200 Grade 0, 0201 | 0201 | ERJ-1GN0R00C | Panasonic | | |
| R29 | 1 | 43.2 | RES, 43.2, 1%, 0.1 W, AEC-Q200 Grade 0, 0402 | 0402 | ERJ2RKF43R2X | Panasonic | | |
| R30, R31, R35, R37, R53 | 5 | 10.0k | RES, 10.0 k, 1%, 0.05 W, 0201 | 0201 | CRCW020110K0FKED | Vishay-Dale | | |
| R34 | 1 | 25.5k | RES, 25.5 k, 1%, 0.05 W, 0201 | 0201 | RC0201FR-0725K5L | Yageo America | | |
| R38 | 1 | 51.0k | RES, 51.0 k, 1%, 0.05 W, 0201 | 0201 | RC0201FR-0751KL | Yageo America | | |

Table 3-1. Bill of Materials (continued)

| Designator | QTY | Value | Description | Package Reference | Part Number | Manufacturer | Alternate Part Number | Alternate Manufacturer |
|-----------------------------------|-----|-------|----------------------------------------------------------------------------------------------------------------------------|-------------------|--------------------|---------------------------|-------------------------------|------------------------|
| R39 | 1 | 47.0k | RES, 47.0 k, 1%, 0.0625 W, 0402 | 0402 | RC0402FR-0747KL | Yageo America | | |
| R40 | 1 | 360 | RES, 360, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402360RJNED | Vishay-Dale | | |
| R41, R46, R48, R69 | 4 | 49.9 | RES, 49.9, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040249R9FKED | Vishay-Dale | CRCW040249R9FKED C, [NoValue] | Vishay-Dale, [NoValue] |
| R42, R43, R44 | 3 | 33 | RES, 33.0, 1%, 0.1 W, 0402 | 0402 | ERJ-2RKF33R0X | Panasonic | ERJ-U02F33R0X | Panasonic |
| R45 | 1 | 0 | RES, 0, 1%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | RMCF0603ZT0R00 | Stackpole Electronics Inc | | |
| R47, R59 | 2 | 10.0k | RES, 10.0 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040210K0FKED | Vishay-Dale | | |
| R49 | 1 | 1.5k | RES, 1.5 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | CRCW06031K50JNEA | Vishay-Dale | CRCW06031K50JNEA C | Vishay-Dale |
| R50, R51 | 2 | 200k | RES, 200 k, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402200KJNED | Vishay-Dale | | |
| R52 | 1 | 680 | RES, 680, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402680RJNED | Vishay-Dale | | |
| R54, R55, R56, R57, R58, R60, R79 | 7 | 0 | RES, 0, 5%, 0.1 W, 0603 | 0603 | RC0603JR-070RL | Yageo | | |
| R61, R62 | 2 | 1 | RES, 1.0, 5%, 0.5 W, 1206 | 1206 | CRM1206-JW-1R0ELF | Bourns | | |
| R63, R64 | 2 | 1 | RES, 1.00, 1%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | CRCW06031R00FKEA | Vishay-Dale | | |
| R65 | 1 | 0 | RES, 0, 5%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | CRCW06030000Z0EA | Vishay-Dale | | |
| R66 | 1 | 147k | RES, 147 k, 1%, 0.1 W, 0603 | 0603 | RC0603FR-07147KL | Yageo | | |
| R67 | 1 | 115k | RES, 115 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402115KFKED | Vishay-Dale | | |
| R68 | 1 | | 10 mOhms \pm 1% 1W Chip Resistor 1206 (3216 Metric) Automotive AEC-Q200, Current Sense, Moisture Resistant Metal Element | 1206 | CRF1206-FZ-R010ELF | Bourns | | |
| R70, R73 | 2 | 102k | RES, 102 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402102KFKED | Vishay-Dale | | |
| R71 | 1 | 120k | RES, 120 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0402 | 0402 | ERJ-2RKF1203X | Panasonic | | |
| R72 | 1 | 45.3k | RES, 45.3 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040245K3FKED | Vishay-Dale | | |
| R74 | 1 | 49.9k | RES, 49.9 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040249K9FKED | Vishay-Dale | | |

Table 3-1. Bill of Materials (continued)

| Designator | QTY | Value | Description | Package Reference | Part Number | Manufacturer | Alternate Part Number | Alternate Manufacturer |
|----------------------------------------------------------------------------------------------------------------------------------------------------|-----|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------|------------------|----------------------|-----------------------|------------------------|
| R75 | 1 | 0 | RES, 0, 5%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW04020000Z0ED | Vishay-Dale | | |
| R76 | 1 | 150k | RES, 150 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW0402150KFKED | Vishay-Dale | | |
| R77 | 1 | 20.0k | RES, 20.0 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040220K0FKED | Vishay-Dale | | |
| R78 | 1 | 11.3k | RES, 11.3 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402 | 0402 | CRCW040211K3FKED | Vishay-Dale | | |
| R80 | 1 | 18.2k | RES, 18.2 k, 1%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 | CRCW060318K2FKEA | Vishay-Dale | | |
| R81, R82 | 2 | 4.70k | RES, 4.70 k, 0.1%, 0.1 W, 0603 | 0603 | RT0603BRD074K7L | Yageo America | | |
| R83, R85 | 2 | 0 | RES, 0, 5%, 0.125 W, 0805 | 0805 | RC0805JR-070RL | Yageo America | | |
| R84 | 1 | 249k | RES, 249 k, 1%, 0.1 W, 0603 | 0603 | RC0603FR-07249KL | Yageo | | |
| S1 | 1 | | Switch, Toggle, SPDT 1Pos, TH | 7 X 11 X4.5 mm | G12AP | NKK Switches | | |
| SH1, SH2, SH3, SH4, SH5, SH6, SH7, SH8, SH9, SH10, SH11, SH12, SH13 | 13 | 1x2 | Shunt, 100mil, Gold plated, Black | Shunt | SNT-100-BK-G | Samtec | 969102-0000-DA | 3M |
| TP1, TP2, TP3, TP4, TP5, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14, TP16, TP17, TP18, TP19, TP20, TP21, TP22, TP24, TP25, TP26, TP27, TP28, TP30 | 26 | | Test Point, Miniature, Orange, TH | Orange Miniature Test point | 5003 | Keystone Electronics | | |
| TP6, TP15, TP29, TP31, TP32, TP33, TP34, TP35 | 8 | | Test Point, Compact, Black, TH | Black Compact Test point | 5006 | Keystone Electronics | | |
| U1, U2 | 2 | | 20W Stereo, Inductor-Less, Digital Input, Closed-Loop Class-D Audio Amplifier with 96Khz Extended Processing and Low Idle Power Dissipation, HTSSOP28 | HTSSOP28 | TAS5815PWPR | Texas Instruments | | |
| U3 | 1 | | 3V to 17V, High Efficiency and Low IQ Buck Converter Module in MicroSiP Package with Integrated Inductor | uSiL11 | TPSM82903SISR | Texas Instruments | | |

Table 3-1. Bill of Materials (continued)

| Designator | QTY | Value | Description | Package Reference | Part Number | Manufacturer | Alternate Part Number | Alternate Manufacturer |
|---------------|-----|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------|-----------------------|-----------------------------|-----------------------|------------------------|
| U4 | 1 | | Single Output LDO, 400mA, Adj. (1.2 to 5.5V), Cap free, Low Noise, Reverse Current Protection, DBV0005A (SOT-23-5) | DBV0005A | TPS73618DBVR | Texas Instruments | | |
| U5 | 1 | | XCore XEF Microcontroller IC 32-Bit 16-Core 2000MIPs 2MB (2M x 8) FLASH 128-TQFP (14x14) | TQFP128 | XEF216-512-TQ128-C20A | XMOS | | |
| U6 | 1 | | 2-Bit Bidirectional 1MHz I2C Bus and SMBus Voltage-Level Shifter, DCU0008A (VSSOP-8) | DCU0008A | TCA9406DCUR | Texas Instruments | | |
| U7 | 1 | | Programmable 1-PLL VCXO Clock Synthesizer with 2.5V or 3.3V LVCMOS Outputs, PW0014A (TSSOP-14) | PW0014A | CDCE913PWR | Texas Instruments | CDCE913PW | Texas Instruments |
| U8 | 1 | | Dual-Bit Dual-Supply Bus Transceiver, DQM0008A (X2SON-8) | DQM0008A | SN74AVC2T244DQMR | Texas Instruments | | |
| U9 | 1 | | Enhanced Product Dual Buffer/Driver with Open-Drain Output, DCK0006A (SOT-SC70-6) | DSF0006A | SN74LVC2G07DSFR | Texas Instruments | | |
| U10 | 1 | | Single-Channel Ultra-Small Adjustable Supervisory Circuit With Active-High Open-Drain Output, DRY0006A (USON-6) | DRY0006A | TPS3897ADRYR | Texas Instruments | | |
| U11 | 1 | | Optical Jack Transmitter OTJ-8 | OTJ8 | FCR684208T | Cliff Electronic Components | | |
| U12 | 1 | | 4-Bit Dual-Supply Bus Transceiver With Configurable Voltage-Level Shifting and 3-State Outputs, RSV0016A (UQFN-16) | RSV0016A | SN74AVC4T774RSVR | Texas Instruments | | Texas Instruments |
| U13 | 1 | | Fiber Optic Receiver Digital Audio, Optical 16Mbps - approx. 2.7V-5.5V 10mA | CONN_FIBER_OPTIC | FCR684208R | Cliff | | |
| U14 | 1 | | 216kHz Digital Audio Interface Transceiver (DIX) with Stereo ADC and Routing, PCM, S / PDIF, ADC, 4.5 - 5.5V for Analog, 2.9 - 3.6V for DIX, -40 to 85 degC, 48-Pin LQFP (PT), Green (RoHS & no Sb/Br) | PT0048A | PCM9211PT | Texas Instruments | | |
| U15, U16, U18 | 3 | | Single 2-Line to 1-Line Data Selector/Multiplexer, DCT0008A, LARGE T&R | DCT0008A | SN74LVC2G157DCTR | Texas Instruments | SN74LVC2G157DCUT | Texas Instruments |

Table 3-1. Bill of Materials (continued)

| Designator | QTY | Value | Description | Package Reference | Part Number | Manufacturer | Alternate Part Number | Alternate Manufacturer |
|------------|-----|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------|-----------------------|---------------------|-----------------------|------------------------|
| U17 | 1 | | Single Schmitt-Trigger Inverter, DCK0005A (SOT-SC70-5) | DCK0005A | SN74LVC1G14DCKR | Texas Instruments | SN74LVC1G14DCKT | Texas Instruments |
| U19 | 1 | | Single 2-Line to 1-Line Data Selector/Multiplexer, DCU0008A, LARGE T&R | DCU0008A | SN74LVC2G157DCUR | Texas Instruments | SN74LVC2G157DCUT | Texas Instruments |
| U20 | 1 | | Low-Voltage 8-Bit I2C and SMBus I/O Expander, 1.65 to 5.5V, -40 to 85 degC, 16-pin QFN (RGT), Green (RoHS & no Sb/Br) | RGT0016A | TCA6408ARGTR | Texas Instruments | | |
| U21 | 1 | | 36V, 16A Buck-boost Converter | VQFN-HR26 | TPS552882RPM | Texas Instruments | | |
| U22 | 1 | | Single Output Fast Transient Response LDO, 1A, Fixed 3.3V Output, 2.7 to 10V Input, with Low IQ, 8-pin SOIC (D), -40 to 125 degC, Green (RoHS & no Sb/Br) | D0008A | TPS76833QDR | Texas Instruments | | |
| Y1 | 1 | | Crystal Oscillator 24MHz ±50ppm HCMOS 3.3V SMD 2x1.6mm | SMD_2MM0_1MM6 | ASA-24.000MHZ-L-T | Abracon | | |
| Y2 | 1 | | Crystal, 24.576MHz, 10pF, SMD | 2.5x0.5x2.0mm | ABM10-24.576MHZ-E20-T | Abracon Corporation | | |

4 Additional Information

4.1 Trademarks

PurePath™ is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

STANDARD TERMS FOR EVALUATION MODULES

1. *Delivery:* TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
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 - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
2. *Limited Warranty and Related Remedies/Disclaimers:*
 - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
 - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
 - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGRADATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。

<https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html>

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

【無線電波を送信する製品の開発キットをお使いになる際の注意事項】 開発キットの中には技術基準適合証明を受けていないものがあります。技術適合証明を受けていないもののご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。

上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。日本テキサス・イ

ンスツルメンツ株式会社

東京都新宿区西新宿 6 丁目 2 4 番 1 号

西新宿三井ビル

3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_02.page

電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。 <https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html>

3.4 European Union

3.4.1 *For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):*

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

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- 4 *EVM Use Restrictions and Warnings:*
 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 *Safety-Related Warnings and Restrictions:*
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
 5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.
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 - 6.1 EXCEPT AS SET FORTH ABOVE, EVMS AND ANY MATERIALS PROVIDED WITH THE EVM (INCLUDING, BUT NOT LIMITED TO, REFERENCE DESIGNS AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY EPIDEMIC FAILURE WARRANTY OR IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.
 - 6.2 EXCEPT FOR THE LIMITED RIGHT TO USE THE EVM SET FORTH HEREIN, NOTHING IN THESE TERMS SHALL BE CONSTRUED AS GRANTING OR CONFERRING ANY RIGHTS BY LICENSE, PATENT, OR ANY OTHER INDUSTRIAL OR INTELLECTUAL PROPERTY RIGHT OF TI, ITS SUPPLIERS/LICENSORS OR ANY OTHER THIRD PARTY, TO USE THE EVM IN ANY FINISHED END-USER OR READY-TO-USE FINAL PRODUCT, OR FOR ANY INVENTION, DISCOVERY OR IMPROVEMENT, REGARDLESS OF WHEN MADE, CONCEIVED OR ACQUIRED.
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9. *Return Policy.* Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.

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